

MOS FIELD EFFECT TRANSISTOR 2SK2137

SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The 2SK2137 is N-Channel MOS Field Effect Transistor designed for high voltage switching applications.

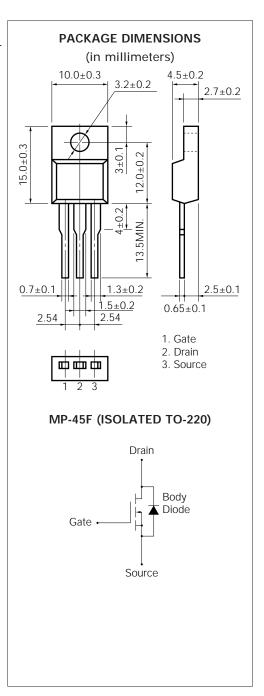
FEATURES

- Low On-Resistance
 - 2SK2137: $R_{DS(on)} = 2.4 \Omega \text{ (VGS} = 10 V, I_D = 2.0 A)$
- Low Ciss Ciss = 550 pF TYP.
- · High Avalanche Capability Ratings
- Isolate TO-220 Package

ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	V_{DSS}	600	V
Gate to Source Voltage	Vgss	±30	V
Drain Current (DC)	ID(DC)	±4.0	Α
Drain Current (pulse)*	ID(pulse)	±16	Α
Total Power Dissipation (Tc = 25 °C)	P _{T1}	30	W
Total Power Dissipation (T _A = 25 °C)	P _{T2}	2.0	W
Channel Temperature	T_ch	150	.C
Storage Temperature	T _{stg}	-55 to +150	.C
Single Avalanche Current**	las	4.0	Α
Single Avalanche Energy**	Eas	5.3	mJ

- * PW \leq 10 μ s, Duty Cycle \leq 1 %
- ** Starting Tch = 25 °C, Rg = 25 Ω , Vgs = 20 V \rightarrow 0

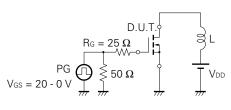


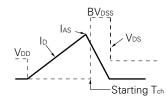


ELECTRICAL CHARACTERISTICS (TA = 25 °C)

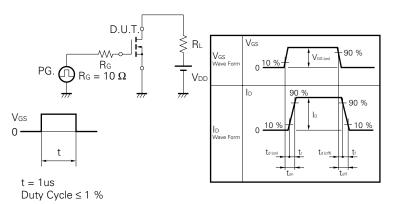
CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-State Resistance	R _{DS(on)}		1.7	2.4	Ω	Vgs = 10 V, ID = 2.0 A
Gate to Source Cutoff Voltage	V _{GS(off)}	2.5		3.5	V	V _{DS} = 10 V, I _D = 1 mA
Forward Transfer Admittance	l yfs l	1.0			S	V _{DS} = 10 V, I _D = 2.0 A
Drain Leakage Current	IDSS			100	μΑ	VDS = VDSS, VGS = 0
Gate to Source Leakage Current	Igss			±100	nA	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0$
Input Capacitance	Ciss		550		pF	V _{DS} = 10 V
Output Capacitance	Coss		130		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		25		pF	f = 1 MHz
Turn-On Delay Time	td(on)		11		ns	ID = 2.0 A
Rise Time	tr		6		ns	V _{GS(on)} = 10 V
Turn-Off Delay Time	td(off)		45		ns	V _{DD} = 150 V
Fall Time	tf		7		ns	$R_G = 10 \Omega R_L = 75 \Omega$
Total Gate Charge	QG		20		nC	ID = 4.0 A
Gate to Source Charge	Qgs		4		nC	V _{DD} = 480 V
Gate to Drain Charge	Q _{GD}		10		nC	V _{GS} = 10 V
Body Diode Forward Voltage	V _{F(S-D)}		1.0		V	IF = 4.0 A, VGS = 0
Reverse Recovery Time	trr		320		ns	IF = 4.0 A, VGS = 0
Reverse Recovery Charge	Qrr		1.2		μC	di/dt = 50 A/μs

Test Circuit 1 Avalanche Capability

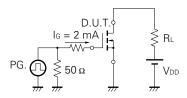




Test Circuit 2 Switching Time

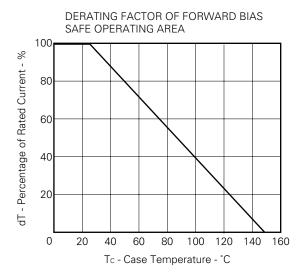


Test Circuit 3 Gate Charge

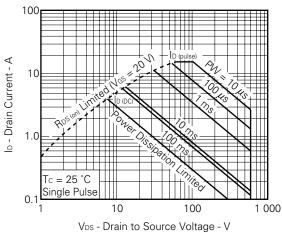


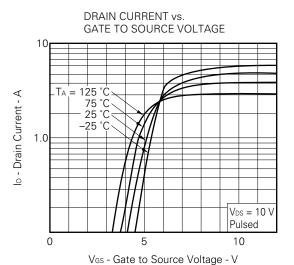
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

TYPICAL CHARACTERISTICS (TA = 25 °C)



FORWARD BIAS SAFE OPERATING AREA





CASE TEMPERATURE 40 P_T - Total Power Dissipation - W 30 20 10

TOTAL POWER DISSIPATION vs.

DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

80

Tc - Case Temperature - °C

100

120

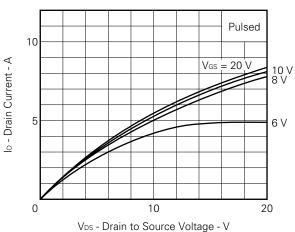
140 160

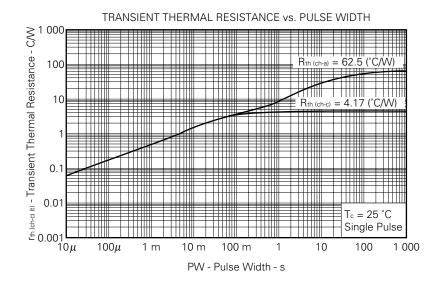
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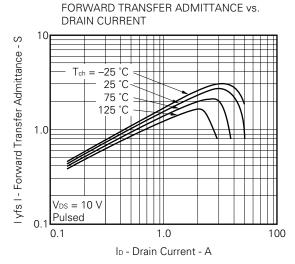
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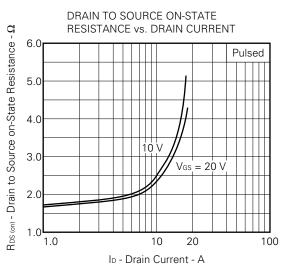
60

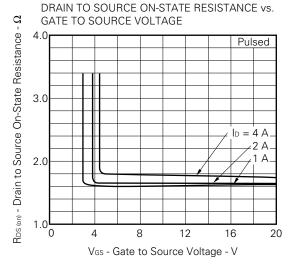
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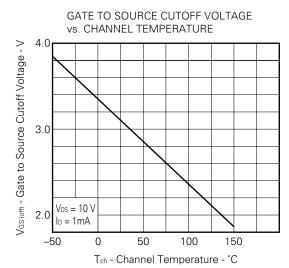


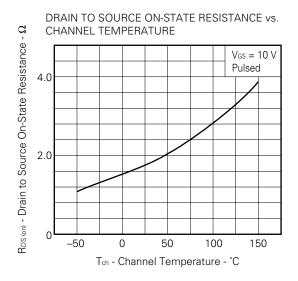


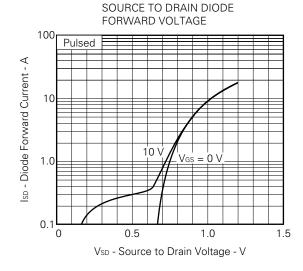


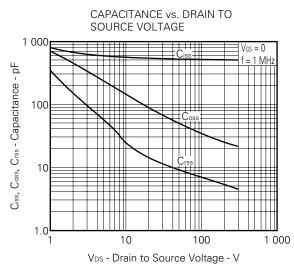


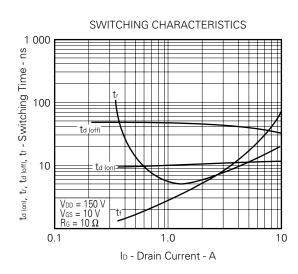


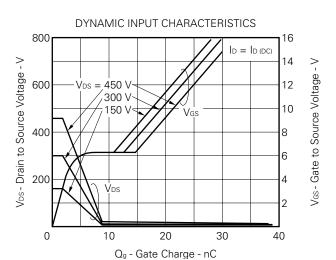


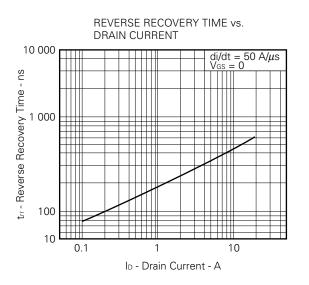








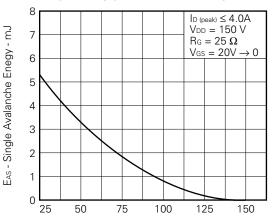






SINGLE AVALANCHE CURRENT vs. INDUCTIVE LOAD 10 Toh = 25 °C RG = 25 Ω Vop = 150 V VGS = 20 V \rightarrow 0 100 μ 1 m 10 m 100 m L - Inductive load - H

SINGLE AVALANCHE ENEGY vs. STARTING CHANNEL TEMPERATURE



Starting Tch-Starting Channel Temperature - °C



REFERENCE

Document Name	Document No.
NEC semiconductor device reliability/quality control system.	TEI-1202
Quality grade on NEC semiconductor devices.	IEI-1209
Semiconductor device mounting technology manual.	IEI-1207
Semiconductor device package manual.	IEI-1213
Guide to quality assurance for semiconductor devices.	MEI-1202
Semiconductor selection guide.	MF-1134
Power MOS FET features and application switching power supply.	TEA-1034
Application circuits using Power MOS FET.	TEA-1035
Safe operating area of Power MOS FET.	TEA-1037

The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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Anti-radioactive design is not implemented in this product.